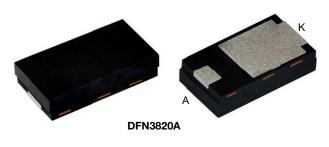
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# High Current Density Surface-Mount Schottky Barrier Rectifier



Anode O Cathode

## LINKS TO ADDITIONAL RESOURCES

Ultra Librarian EDA/CAD	Application Notes	Packages	Marking	Related Documents
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PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	5.0 A			
V <sub>RRM</sub>	40 V			
I <sub>FSM</sub>	140 A			
$V_F$ at $I_F$ = 2.5 A ( $T_J$ = 125 °C)	0.33 V			
T <sub>J</sub> max.	150 °C			
Package	DFN3820A			
Circuit configuration	Single			

## FEATURES

- Low profile package typical height of 0.88 mm
  Available
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Guardring for overvoltage protection
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  Automotive ordering code; base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### **MECHANICAL DATA**

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SS5N42	UNIT		
Device marking code		S54			
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	40	V		
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> <sup>(1)</sup>	5	А		
Maximum average forward rectilied current (lig. 1)	I <sub>F(AV)</sub> <sup>(2)</sup>	2.5	А		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	140	А		
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +150	°C		
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C		

#### Notes

<sup>(1)</sup> With infinite heatsink

(2) Free air, mounted on FR4 PCB, 2 oz., standard footprint

<sup>(3)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

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RoHS

COMPLIANT HALOGEN

FREE

SS5N42



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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_J = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	- T <sub>J</sub> = 25 °C	V <sub>E</sub> <sup>(1)</sup>	0.43	-	V
	$I_{F} = 5.0 \text{ A}$			0.48	0.53	
	I <sub>F</sub> = 2.5 A	– T <sub>J</sub> = 125 °C	VF ()	0.33	0.33 -	v
	I <sub>F</sub> = 5.0 A			0.42	0.48	
Deverse eurrent	V <sub>R</sub> = 40 V	T <sub>J</sub> = 25 °C T <sub>J</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.24	mA
Reverse current	v <sub>R</sub> = 40 v	T <sub>J</sub> = 125 °C	IR (-)	12	25	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		215	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Thermal resistance	R <sub>0JA</sub> (1)(2)	135	169	°C/W
	R <sub>θJM</sub> <sup>(3)</sup>	5	6.3	C/W

#### Notes

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC® 51-14 transient dual interface test method (TDIM)

### **ORDERING INFORMATION TABLE**

**Device code** SS 5 2 Ν 4 н **M**3 (2)(3) (5) (6)(4 7 1 1 Vishay planar Schottky product 2 Current rating (5 = 5 A)3 Package type (N = DFN3820A) 4 Voltage rating (4 = 40 V) \_ 5 Planar Schottky generation option (2 = Gen 2) 6 Quality grade (H = AEC-Q101 qualified, otherwise = industry grade) 7 Material / Environmental category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS5N42-M3/H	0.023	Н	3500	7" diameter plastic tape and reel	
SS5N42-M3/I	0.023	I	14 000	13" diameter plastic tape and reel	
SS5N42HM3/H <sup>(1)</sup>	0.023	Н	3500	7" diameter plastic tape and reel	
SS5N42HM3/I <sup>(1)</sup>	0.023	I	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified

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## **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

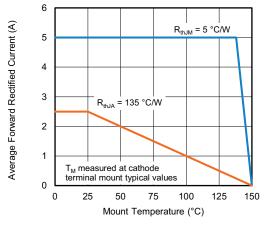


Fig. 1 - Maximum Forward Current Derating Curve

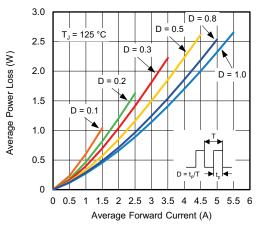


Fig. 2 - Forward Power Loss Characteristics

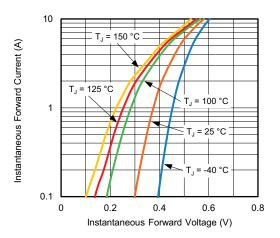


Fig. 3 - Typical Instantaneous Forward Characteristics

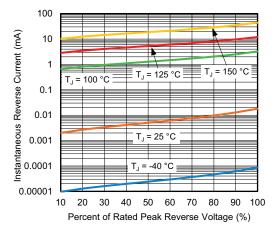


Fig. 4 - Typical Reverse Characteristics

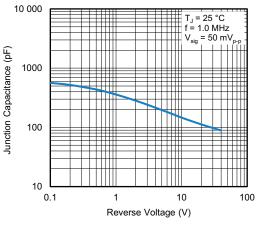


Fig. 5 - Typical Junction Capacitance

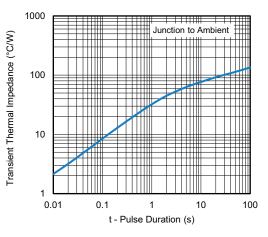


Fig. 6 - Typical Transient Thermal Impedance

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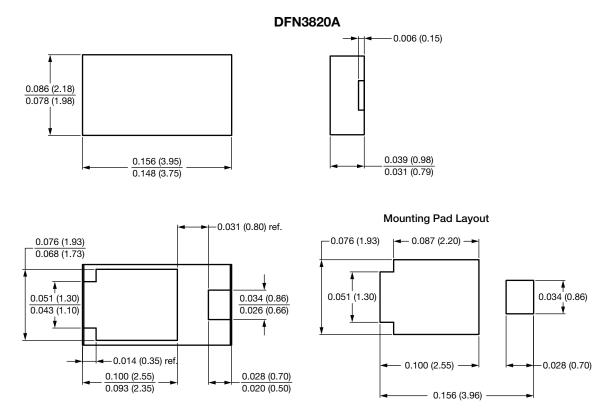
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## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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